

EAST Search History**EAST Search History (Prior Art)**

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	3	"20050021172"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 10:46
S2	7	(ic (integrated adj circuit)) with (corrugat\$3 adj (board sheet substrate)) with roll	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 10:48
S3	241	(ic (integrated adj circuit) chip) with (corrugat\$3 adj (board sheet substrate))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 10:50
S4	9	(ic (integrated adj circuit) chip) with (corrugat\$3 adj (board sheet substrate)) with roll	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 10:50
S5	14934	235/375,451,492,487,488.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 10:51
S6	5774	340/5.1,572.1.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 10:51
S7	20181	S5 S6	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 10:51
S8	2	S3 and S7	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 10:51

S9	9	((ic (integrated adj circuit) chip) adj tag) with (corrugat\$3 adj (board sheet substrate))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 10:52
S10	2	"6943678".pn.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 10:54
S11	223	("20020017745" "20020020487" "20020020705" "3398434" "3583036" "3597799" "3695188" "3702100" "3779687" "3783078" "3787158" "3867088" "3868209" "3919382" "3919445" "3919446" "3964400" "4013021" "4070839" "4079232" "4101252" "4113909" "4133270" "4158539" "4164387" "4164389" "4194663" "4244915" "4255382" "4287836" "4348442" "4377377" "4428306" "4464329" "4488496" "4500213" "4507348" "4509432" "4509909" "4513048" "4531901" "4555381" "4600376" "4606278" "4608009" "4636348" "4649007" "46666544" "4742781" "4801347" "4846077" "4907515" "4969812" "5007225" "5030501" "5042396" "5046434" "5071603" "5088418" "5108529" "5117762" "5123359" "5123541" "5143778" "5156782" "5164211" "5167969" "5168817" "5197395" "5197396" "5225213" "5226373" "5229648" "5255613" "5283028" "5283029" "5329861" "5329862" "5337681" "5351627" "5351628" "5351629" "5367960" "5367961" "5390467" "5391251" "5401347" "5402735" "5404829" "5407632" "5408937" "5413052" "5427732" "5448110" "5470641" "5479416" "5492069" "5505141" "5517188" "5527585" "5531585" "5535668" "5539775" "5555820" "5583819" "5596933" "5606921" "5620715" "5624622" "5624630" "5635129" "5635306" "5638760" "5649295" "5657007" "5661457" "5664322" "5676064" "5686928" "5687652" "5708423" "5716581" "5755162" "5769003"). PN. OR ("5774876" "5778801" "5782129" "5791262" "5794542" "5794544" "5800846" "5813355" "5814185" "5818348" "5822683" "5822714" "5830299" "5836255" "5843366" "5845588" "5860369" "5862760" "5868080" "5879495" "5885691" "5894803" "5900203"	OR	ON	2010/05/28 10:54	

		"5908135" "5921189" "5929779" "5933354" "5936527" "5942987" "5950545" "5950546" "5955950" "5963144" "5967057" "5971592" "5973599" "5975879" "5980231" "5986569" "5986570" "5993724" "5999091" "6006677" "6013949" "6018641" "6018927" "6021721" "6025780" "6027027" "6029583" "6199488" "6483434").PN. OR ("6943678").URPN.				
S12	807	(ic (integrated adj circuit) chip) same (corrugat\$3 adj (board sheet substrate))	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 10:55
S13	0	S11 and S12	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 10:56
S14	27385	(corrugat\$3 adj (board sheet substrate))	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 10:56
S15	6	S11 and S14	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 10:56
S16	0	S15 and (ic (integrated adj circuit) chip)	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 10:56
S17	9	((ic (integrated adj circuit)) adj tag) with (corrugat\$3 adj (board sheet substrate))	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 11:10
S18	9	((ic (integrated adj circuit)) adj tag) with (corrugat\$3 adj (board sheet substrate box))	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 11:11
S19	34289	(ic (integrated adj circuit) chip) with attach\$3 with (board sheet substrate medium)	US_PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 11:12

S20	493	S19 and S7	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 11:12
S21	222003	corrugat\$3	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 11:12
S22	12	S20 and S21	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 11:12
S23	2	"20020030597".pn.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 12:08
S24	1	"6943678".pn. and bond\$3	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 15:54
S25	1	((ic (integrated adj circuit)) adj tag) same attach\$3 same (((cardboard (card adj board) box\$2)sheet substrate) medium paper) same ((starch adj past\$3) (vinyl adj acetate adj emulsion))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 15:58
S26	775	((ic (integrated adj circuit)) adj tag) same attach\$3 same (((cardboard (card adj board) box\$2)sheet substrate) medium paper)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 15:59
S27	13475	((starch adj past\$3) (vinyl adj acetate adj emulsion))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 15:59
S28	12	S26 and S27	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/05/28 15:59
S29	4	("20030166812" "20030179093" "20080202300" "6368707").PN. OR ("7561047").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2010/05/28 16:05

S30	2	S29 and resin	US-PGPUB; USPAT; USOCR	OR	ON	2010/05/28 16:05
S31	1	"20070241900".pn. and bond\$3	US-PGPUB; USPAT; USOCR	OR	ON	2010/05/28 16:07
S32	1	"20070241900".pn. and (bond\$3 same attach\$3)	US-PGPUB; USPAT; USOCR	OR	ON	2010/05/28 16:22
S33	36076	(ic (integrated adj circuit) chip) with attach\$3 with (board sheet substrate medium box)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/09/19 21:37
S34	36113	(ic (integrated adj circuit) chip) with attach\$3 with (board sheet substrate medium box carton)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/09/19 21:37
S35	9350	calculat\$3 same trim\$4	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/09/19 21:38
S36	30	S34 and S35	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/09/19 21:38
S37	27003	(ic (integrated adj circuit) chip) with attach\$3 with (sheet substrate medium box carton)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/09/19 21:48
S38	1739	calculat\$3 same trim\$4 same cut\$4	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/09/19 21:49
S39	2	S37 and S38	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/09/19 21:49
S40	0	((ic (integrated adj circuit) chip) with (corrugat\$3 adj (sheet substrate box carton))) same calculat\$3 same trim \$4	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/09/19 21:54

S41	146	((ic (integrated adj circuit) chip) with (corrugat\$3 adj (sheet substrate box carton)))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/09/19 21:56
S42	4008703	trim\$3 cut\$4	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/09/19 21:56
S43	69	S41 and S42	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2010/09/19 21:56

EAST Search History (Interference)

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S44	14217	(ic (integrated adj circuit) chip) with attach\$3 with (board sheet substrate medium box carton)	USPAT; UPAD	OR	ON	2010/09/23 16:23
S45	82	calculat\$3 same (trim (set adj trim adj data)) same cut\$4	USPAT; UPAD	OR	ON	2010/09/23 16:26
S46	0	S44 and S45	USPAT; UPAD	OR	ON	2010/09/23 16:26
S47	704016	(ic (integrated adj circuit) chip)	USPAT; UPAD	OR	ON	2010/09/23 16:26
S48	23	S45 and S47	USPAT; UPAD	OR	ON	2010/09/23 16:27
S49	3466913	manufactur\$3 produc\$4	USPAT; UPAD	OR	ON	2010/09/23 16:32
S51	2827	S44 same S49	USPAT; UPAD	OR	ON	2010/09/23 16:32
S52	1304893	trim\$4 cut\$4	USPAT; UPAD	OR	ON	2010/09/23 16:33
S53	257	S51 same S52	USPAT; UPAD	OR	ON	2010/09/23 16:33
S54	5655	235/451,492,383,385.ccls.	USPAT; UPAD	OR	ON	2010/09/23 16:33
S55	3201	340/572.1,572.2.ccls.	USPAT; UPAD	OR	ON	2010/09/23 16:33
S56	8461	S54 S55	USPAT; UPAD	OR	ON	2010/09/23 16:33
S57	7	S56 and S53	USPAT; UPAD	OR	ON	2010/09/23 16:33

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